

A

B

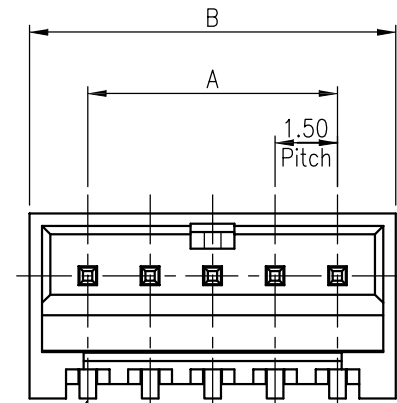
C

D

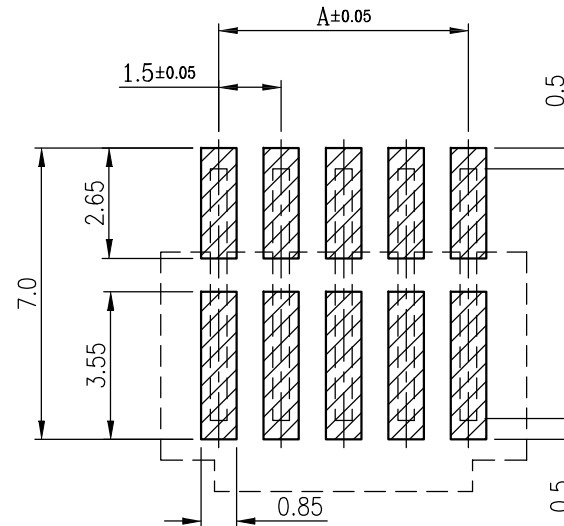
E

F

修 订	标 记	修 改 描 要	签 名	日 期
REV AO		NEW DRG		2016-03-12



Circuit No.1



RECOMMEND PCB LAYOUT

NOTES:

1. MATERIAL:

1.1 HOUSING: HALOGEN FREE PLASTIC, HIGH TEMP.,
UL94V-0.

1.2 CONTACT: COPPER ALLOY

2. FINISH:

1. GOLD FLASH PLATING(1~3u"), UNDER NICKEL PLATED.

N: 100~200u" Matt Tin PLATING, UNDER NICKEL PLATED. (Lead Free)

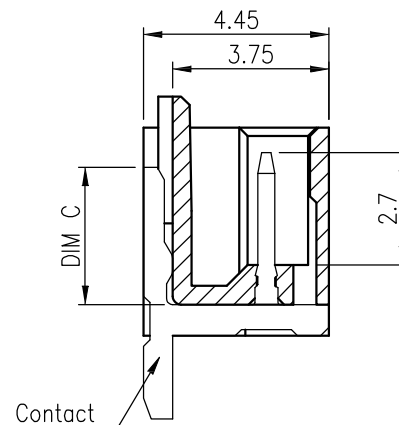
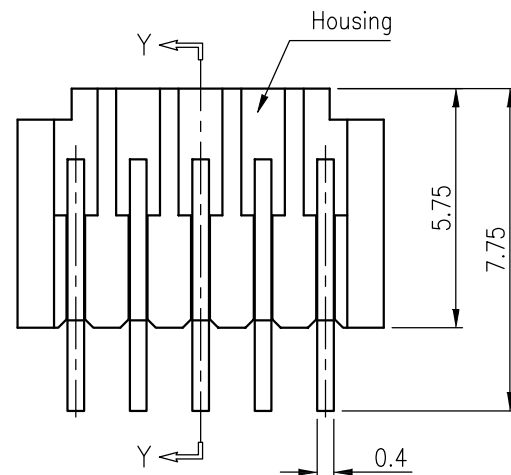
L: 100~200u" Tin PLATING, UNDER NICKEL PLATED.

3. REFLOW SOLDER CAPABLE TO 260. C

4. SPEC. PLS. REFER TO PS-WB1502-XXXX-XXX

5. PACKAGE PLS. REFER TO WB1502 -XXXX-TRP

6. PART NUMBER



SEC. Y-Y

CKT	DIM A	DIM B
2	1.5	4.3
3	3.0	5.8
4	4.5	7.3
5	6.0	8.8
6	7.5	10.3
7	9.0	11.8
8	10.5	13.3
9	12.0	14.8



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Shenzhen Huade co-create Technology Co.,LTD

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-TOLERANCES- UNLESS OTHERWISE SPECIFIED 公差参数表		TITLE: 产品名称: MX1.5卧贴针座	
X.X ±0.30	X.X* ±3°	APPD: 核准:	PART NO: 产品编号: HDGC1502WR-S-XP
X.XX ±0.20	X.XX* ±2°	CHECK: 校对: 王建业	DATE SCALE UNIT CODE NUMBER
X.XXX ±0.10	X.XXX* ±1°	DRAW: 绘图: 黄艳兰	2016-03-12 1:1 mm A001